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Part Number: **0739440000**
Status: **Active**
Overview: HDM Backplane Connector System
Description: HDM Board-to-Board Backplane Header, Vertical, SMC, Solder Tail, Guide Pin Option, Guide Post Location B, Polarizing Key Position A, 72 Circuits

Documents:

[3D Model](#) [Product Specification PS-73670-9999-001 \(PDF\)](#)
[3D Model \(PDF\)](#) [Packaging Specification PK-70873-0818-001 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
 UL E29179

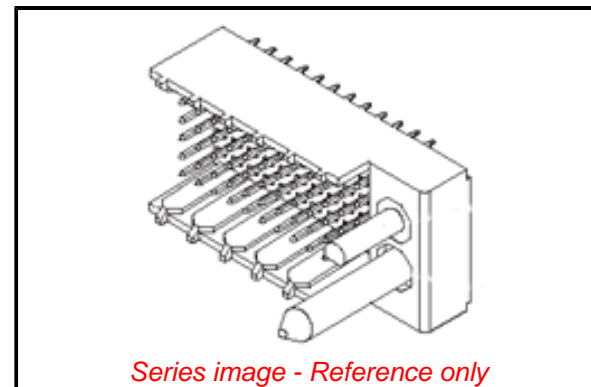
General

Product Family Backplane Connectors
 Series 73944
 Application Backplane
 Component Type PCB Header
 Overview HDM Backplane Connector System
 Product Name HDM
 UPC 800755030952

Physical

Circuits (Loaded) 72
 Circuits (maximum) 72
 Color - Resin Black, Natural
 Durability (mating cycles max) 250
 First Mate / Last Break No
 Flammability 94V-0
 Guide to Mating Part Yes
 Keying to Mating Part Yes
 Material - Metal Phosphor Bronze, Stainless Steel
 Material - Plating Mating Gold
 Material - Plating Termination Tin
 Material - Resin High Temperature Thermoplastic
 Number of Columns 12
 Number of Pairs Open Pin Field
 Number of Rows 6
 Orientation Vertical
 PC Tail Length 2.00mm
 PCB Locator Yes
 PCB Retention None
 PCB Thickness - Recommended 2.50mm
 Packaging Type Tube
 Pitch - Mating Interface 2.00mm
 Pitch - Termination Interface 2.00mm
 Plating min - Mating 0.762µm
 Plating min - Termination 2.540µm
 Polarized to PCB No
 Stackable No
 Surface Mount Compatible (SMC) No
 Temperature Range - Operating -55° to +105°C
 Termination Interface: Style Through Hole

Electrical



EU ELV

Not Reviewed

EU RoHS

Not Reviewed

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

For more information, please visit [Contact US](#)

China ROHS

Not Reviewed

ELV

Not Reviewed

RoHS Phthalates

Not Reviewed

Search Parts in this Series

73944 Series

Mates With

73632 HDM+ Board-to-Board Daughtercard Receptacle. 73780 HDM Board-to-Board Daughtercard Receptacle

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
Extraction Tool	621001000

Current - Maximum per Contact	1.0A
Data Rate	1.0 Gbps
Shielded	No
Voltage - Maximum	250V AC

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-70873-0818-001
Product Specification	PS-73670-9999-001
Sales Drawing	SD-73944-001

This document was generated on 07/30/2021

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